

2N6504 Series

Preferred Device

Silicon Controlled Rectifiers

Reverse Blocking Thyristors

Designed primarily for half-wave ac control applications, such as motor controls, heating controls and power supply crowbar circuits.

Features

- Glass Passivated Junctions with Center Gate Fire for Greater Parameter Uniformity and Stability
- Small, Rugged, Thermowatt Constructed for Low Thermal Resistance, High Heat Dissipation and Durability
- Blocking Voltage to 800 Volts
- 300 A Surge Current Capability
- Pb-Free Packages are Available*



ON Semiconductor®

<http://onsemi.com>

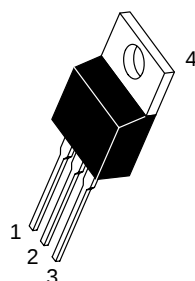
SCRs

25 AMPERES RMS

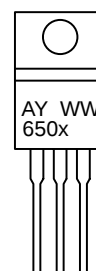
50 thru 800 VOLTS



MARKING DIAGRAM



**TO-220AB
CASE 221A
STYLE 3**



x = 4, 5, 7, 8 or 9
A = Assembly Location
Y = Year
WW = Work Week

PIN ASSIGNMENT

PIN ASSIGNMENT	
1	Cathode
2	Anode
3	Gate
4	Anode

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

2N6504 Series

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
*Peak Repetitive Off-State Voltage (Note 1) (Gate Open, Sine Wave 50 to 60 Hz, T _J = 25 to 125°C) 2N6504 2N6505 2N6507 2N6508 2N6509	V _{DRM} , V _{RRM}	50 100 400 600 800	V
On-State Current RMS (180° Conduction Angles; T _C = 85°C)	I _{T(RMS)}	25	A
Average On-State Current (180° Conduction Angles; T _C = 85°C)	I _{T(AV)}	16	A
Peak Non-repetitive Surge Current (1/2 Cycle, Sine Wave 60 Hz, T _J = 100°C)	I _{TSM}	250	A
Forward Peak Gate Power (Pulse Width ≤ 1.0 μs, T _C = 85°C)	P _{GM}	20	W
Forward Average Gate Power (t = 8.3 ms, T _C = 85°C)	P _{G(AV)}	0.5	W
Forward Peak Gate Current (Pulse Width ≤ 1.0 μs, T _C = 85°C)	I _{GM}	2.0	A
Operating Junction Temperature Range	T _J	-40 to +125	°C
Storage Temperature Range	T _{stg}	-40 to +150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
*Thermal Resistance, Junction-to-Case	R _{θJC}	1.5	°C/W
*Maximum Lead Temperature for Soldering Purposes 1/8 in from Case for 10 Seconds	T _L	260	°C

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

*Peak Repetitive Forward or Reverse Blocking Current (V _{AK} = Rated V _{DRM} or V _{RRM} , Gate Open)	I _{DRM} , I _{RRM}	-	-	10	μA
T _J = 25°C T _J = 125°C		-	-	2.0	mA

ON CHARACTERISTICS

*Forward On-State Voltage (Note 2) (I _{TM} = 50 A)	V _{TM}	-	-	1.8	V
*Gate Trigger Current (Continuous dc) (V _{AK} = 12 Vdc, R _L = 100 Ω)	I _{GT}	-	9.0	30	mA
T _C = 25°C T _C = -40°C		-	-	75	
*Gate Trigger Voltage (Continuous dc) (V _{AK} = 12 Vdc, R _L = 100 Ω, T _C = -40°C)	V _{GT}	-	1.0	1.5	V
Gate Non-Trigger Voltage (V _{AK} = 12 Vdc, R _L = 100 Ω, T _J = 125°C)	V _{GD}	0.2	-	-	V
*Holding Current (V _{AK} = 12 Vdc, Initiating Current = 200 mA, Gate Open)	I _H	-	18	40	mA
T _C = 25°C T _C = -40°C		-	-	80	
*Turn-On Time (I _{TM} = 25 A, I _{GT} = 50 mAdc)	t _{gt}	-	1.5	2.0	μs
Turn-Off Time (V _{DRM} = rated voltage) (I _{TM} = 25 A, I _R = 25 A) (I _{TM} = 25 A, I _R = 25 A, T _J = 125°C)	t _q	-	15	-	μs
		-	35	-	

DYNAMIC CHARACTERISTICS

Critical Rate of Rise of Off-State Voltage (Gate Open, Rated V _{DRM} , Exponential Waveform)	dv/dt	-	50	-	V/μs
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*Indicates JEDEC Registered Data.

2. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.

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Voltage Current Characteristic of SCR

Symbol	Parameter
V_{DRM}	Peak Repetitive Off State Forward Voltage
I_{DRM}	Peak Forward Blocking Current
V_{RRM}	Peak Repetitive Off State Reverse Voltage
I_{RRM}	Peak Reverse Blocking Current
V_{TM}	Peak On State Voltage
I_H	Holding Current

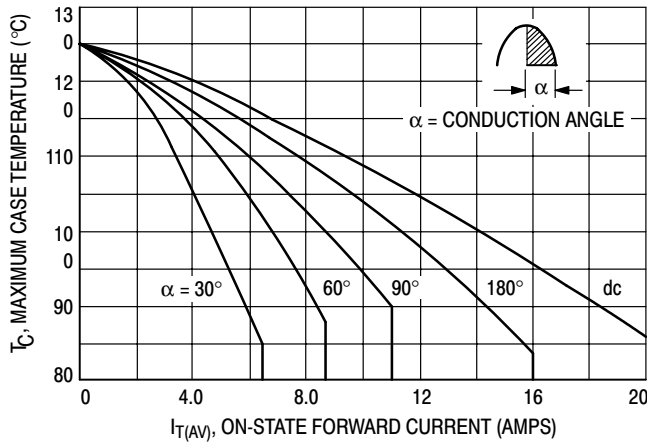
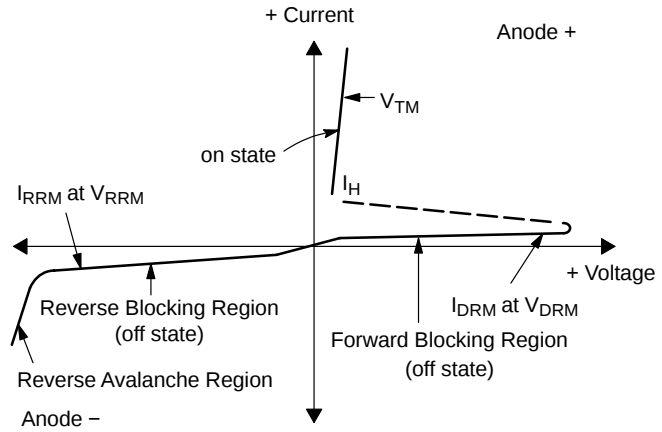


Figure 1. Average Current Derating

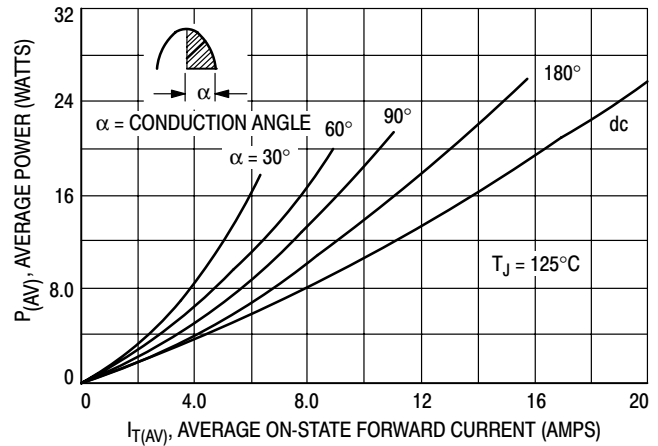


Figure 2. Maximum On-State Power Dissipation

ORDERING INFORMATION

Device	Package	Shipping [†]
2N6404	TO-220AB	500 Units / Box
2N6405	TO-220AB	
2N6405T	TO-220AB	
2N6407	TO-220AB	
2N6407T	TO-220AB	
2N6407TG	TO-220AB (Pb-Free)	
2N6408	TO-220AB	
2N6408G	TO-220AB (Pb-Free)	
2N6409	TO-220AB	
2N6409G	TO-220AB (Pb-Free)	
2N6409T	TO-220AB	

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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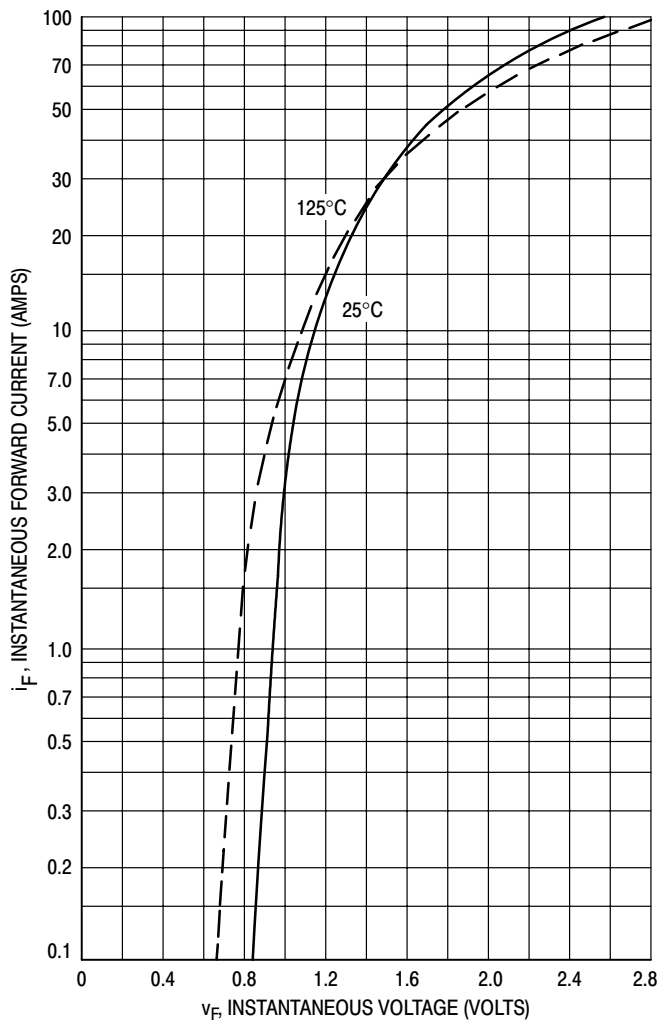


Figure 3. Typical On-State Characteristics

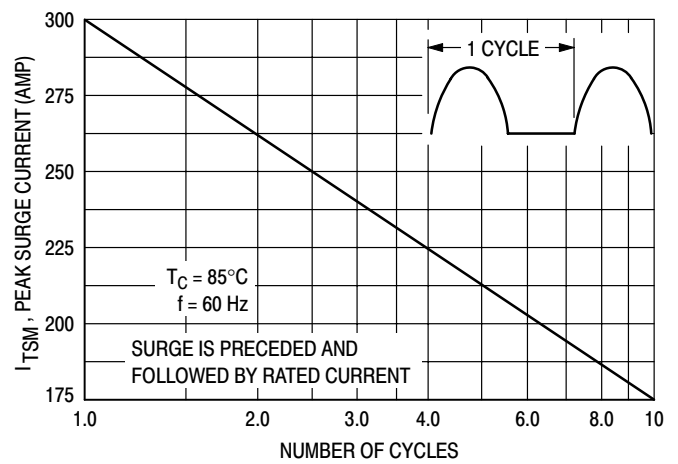


Figure 4. Maximum Non-Repetitive Surge Current

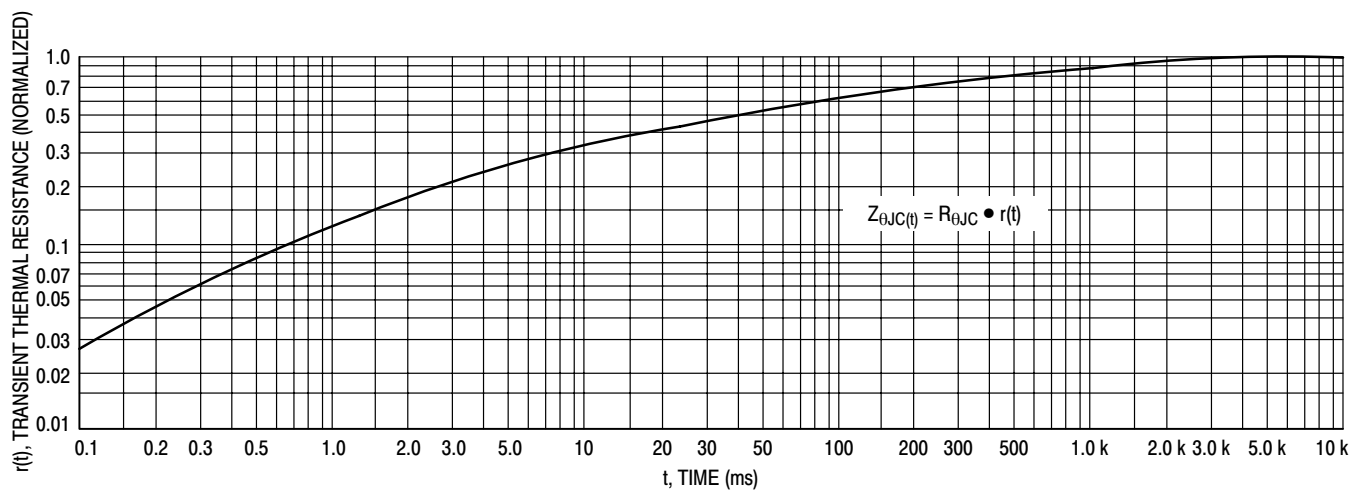


Figure 5. Thermal Response

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TYPICAL TRIGGER CHARACTERISTICS

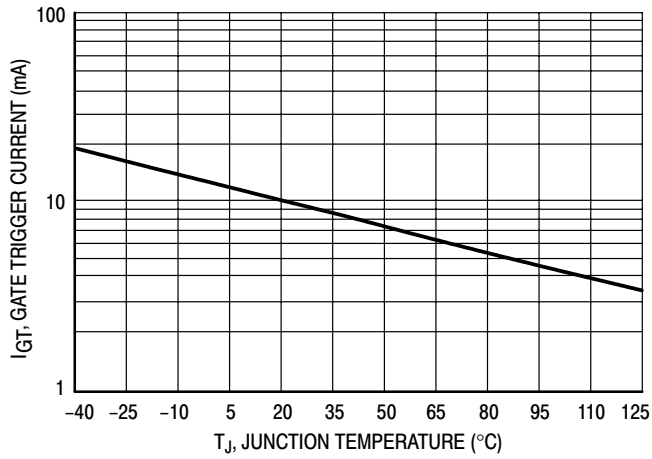


Figure 6. Typical Gate Trigger Current versus Junction Temperature

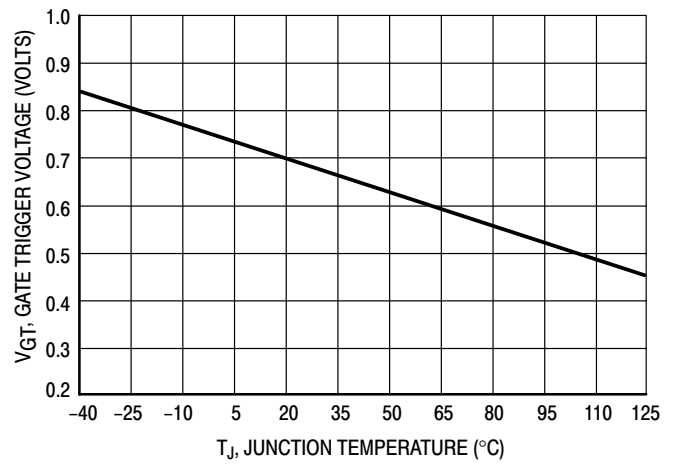


Figure 7. Typical Gate Trigger Voltage versus Junction Temperature

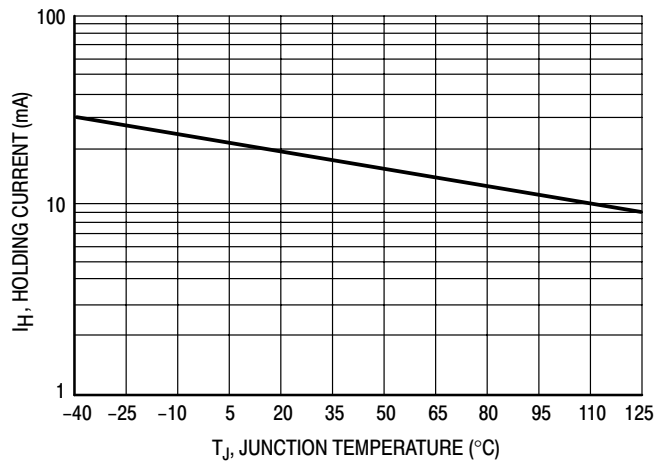
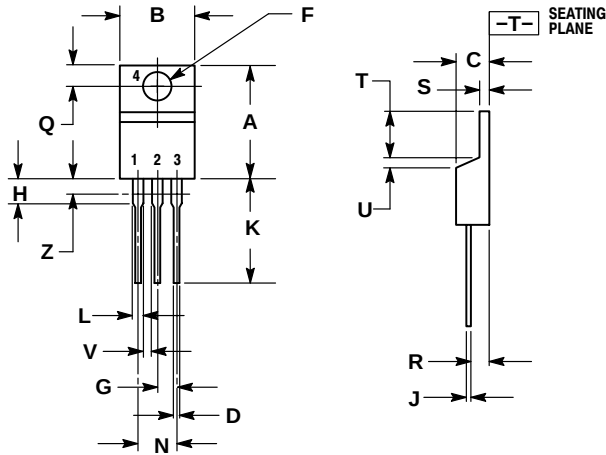


Figure 8. Typical Holding Current versus Junction Temperature

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PACKAGE DIMENSIONS

TO-220AB
CASE 221A-09
ISSUE AA



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.570	0.620	14.48	15.75
B	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
H	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	---	1.15	---
Z	---	0.080	---	2.04

STYLE 3:

- PIN 1. CATHODE
2. ANODE
3. GATE
4. ANODE

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